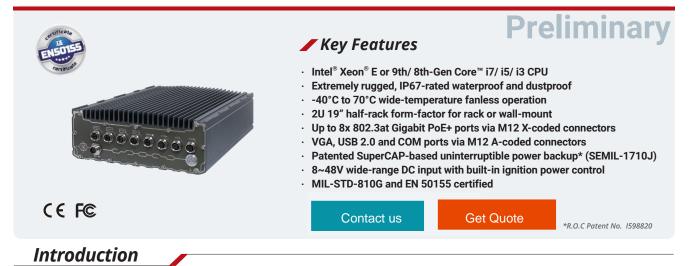


SEMIL-1700 Series

Half-rack IP67 Waterproof Computer Supporting Intel® Xeon® E or 9th/ 8th-Gen Core™ Processor with All M12 Connectors



SEMIL-1700 series is an extremely rugged 2U half-rack computer with an IP67-rated waterproof and dustproof design. Powered by Intel[®] Xeon[®] E or 9th/ 8th-Gen Core™ CPU and coupled with workstation-grade Intel[®] C246 chipset, it can support up to 64 GB ECC/ non-ECC DDR4 memory. The 2U half-rack form-factor SEMIL-1700 series incorporates Neousys' best-in-class thermal design and offers mounting flexibility where you can wall or rack-mount up to two SEMILs side by side.

SEMIL-1700 adopts a corrosion-proof chassis made of stainless steel and aluminum to counteract against moisture and salinity. Offering a variety of I/ O connectivities that utilize M12 connectors to guarantee extremely rugged connections in shock and vibration environments, it has up to eight 802.3at PoE+ ports to supply 25W of power to connected devices. Internal expansion wise, it has an M.2 M-key socket to support NVMe SSD and mini-PCIe sockets for extending feature sets. Additionally, SEMIL-1700 features two 2.5" SATA SDD/ HDD accommodation, 8-48V wide-range DC input with ignition power control and complies with MIL-STD-810G and EN 50155.

To top it off, SEMIL-1710J is equipped with Neousys' innovative SuperCAP-based UPS* containing 2500 watt-second stored energy to sustain or safely shut down the system during unforeseen power outages. Protected against water, dust, high/ low temperature, shock/ vibration and power interruption, Neousys' SEMIL-1700 series is set to redefine edge application computing, where ruggedness matter.

	SEMIL-1704 SEMIL-1714J	SEMIL-1708 SEMIL-1718J		SEMIL-1704	SEMIL-1714J	SEMIL-1708	SEMIL-1718J
System Core	·		Expansion Bus				
Processor	Supporting Intel [®] Xeon [®] E and 9 th /8 th -Gen CPU (LGA1151 socket) - Xeon E 2278GE (8C/16T) / 2278GEL (8C/16T) / 2176G (6C/12T) - I7-9700E, I7-9700TE, I7-8700, I7-8700T - I5-9500E, I5-9500TE, I5-8500, I5-8500T - I3-9100E, I3-9100TE, I3-8100, I3-8100T		Mini PCI-E	2x full-size mini PCI Express socket (mux with mSATA) 2x full-size mini PCI Express soc (mux with mSATA) 2x full-size mini PCI Express soc		ГА)	
			Power Supply				
Chipset	Intel [®] C246 platform controller hub		DC Input	8~48V DC input (M12 S-coded)			
Graphics	Integrated Intel [®] UHD Graphics 630		Ignition Control	Built-in ignition power control (IGN/ GND signal via M12 serial port connector)			
Memory	Up to 64 GB ECC/ non-ECC DD (two SODIMM sockets)	SuperCAP UPS					
AMT	Support	ts AMT 12.0	Capacity	-	2500 watt-second	-	2500 watt-second
ТРМ	Suppor	ts TPM 2.0	Mechanical				
I/O Interface			Dimension	220mm (W) x 310mm (D) x 90.5mm (H)			
	1x IEEE 802.3at (25.5W) Gigabit PoE+ ports by Intel® I219 (M12 X-coded)		Weight	5.8 kg	6 kg	5.9 kg	6.2 kg
PoE+	3x IEEE 802.3at (25.5W) Gigabit 7x IEEE 802.3at (25.5W) Gigabit		Mounting	Rack-mounting and wall-mounting			
	PoE+ ports by Intel [®] I210 (M12 X-coded)	PoE+ ports by Intel [®] I210 (M12 X-coded)	Environmental				
10 GbE Port (Build Option)	Optional: 1x 10 GbE port by Intel [®] X550AT controller (M12 X-coded)**		Operating Temperature	<pre>with 35W CPU -40°C ~ 70°C **** with >= 65W CPU -40°C ~ 70°C ***/ **** (configured as 35W TDP mode) -40°C ~ 50°C ***/ **** (configured as 65W TDP mode)</pre>			
Native Video Port	1x VGA (M12 A-coded), supporting 1920 x 1200 resolution						
Series Port	2x 3-wires RS-232 ports COM1 & COM2 (M12 A-coded)						
USB	2x USB 2.0 (M12 A-coded)	4x USB 2.0 (M12 A-coded)	mSATA	10%~90% , n	on-condensing		
	1x USB 2.0 (internal)	1x USB 2.0 (internal)	Storage Temperature	-40°C ~85°C			
Audio	-	(M12 A-coded)	Humidity	10%~90% . n	on-condensing		
Storage Interface			Vibration	MIL-STD-810G, Method 514.7, Category 4			
SATA HDD	2x Internal SATA port for 2.5" HDD/ SSD installation, supporting RAID 0/ 1		Shock	MIL-STD-810G, Method 516.7, Procedure I			
mSATA	2x full-size mSATA port (mux with mini-PCle)		EMC	EN-50155, CE/FCC Class A, according to EN 55032 & EN 55035			
M.2	1x M.2 2280 M key socket or Intel [®] Optane™ memor	** For optional 10GbE su *** For Xeon E 2176G/ 2. shall be limited to 50°C a CPU power in BIOS to obt **** For sub-zero operatir	278GE, i7-9700E, and nd thermal throttling r tain higher operating t	i7-8700 running at 65 nay occur when sustair emperature.	ned full-loading applie	ed. Users can configure	



Appearance 2x USB2.0 (A-coded) 2x COM (A-coded) 10GbE (X-coded)* 4x PoE + (X-coded) VGA (A 0 8V~48V DC IN (S-coded) **Dimensions** Unit : mm Mounting Configuration 00000000 0000000 310 ▲ Dual SEMIL 19" rack-monuted 0000000 0000000000 Dual SEMIL wall-mounted 86.5 00000000 220 ▲ Single SEMIL wall-mounted

Ordering Information

Model No.	Product Description	
SEMIL-1704	Half-rack IP67 waterproof computer supporting Intel [®] Xeon [®] E or 9th / 8th-Gen Core™ processor with 4x M12 PoE+ ports	
SEMIL-1714J	Half-rack IP67 waterproof computer supporting Intel [®] Xeon [®] E or 9th / 8th-Gen Core™ processor with 4x M12 PoE+ ports and SuperCAP UPS	
SEMIL-1708	Half-rack IP67 waterproof computer supporting Intel [®] Xeon [®] E or 9th / 8th-Gen Core™ processor with 8x M12 PoE+ ports	
SEMIL-1718J	Half-rack IP67 waterproof computer supporting Intel [®] Xeon [®] E or 9th / 8th-Gen Core [™] processor with 8x M12 PoE+ ports and SuperCAP UPS	

Optional Accessories

Joint-plate	Joint plate for dual SEMIL assembly	
M12-Cable-Kit	4x PoE+, VGA, 2x USB2.0 (by Y-cable), 2x COM (by Y-cable) and DC power cables	
PA-160W-OW	160W AC-DC power adapter, 20V/8A; 18AWG/120cm; cord end terminals for terminal block, operating temperature : -30 to 70°C.	
PA-120W-OW	120W AC/DC power adapter, 20V/6A; 18AWG/120cm; cord end terminals for terminal block, operating temperature : -30 to 70°C.	